	Title	Current R
1	System and method for resetting a reaction mass assembly of a stage ass mbly	355/72
2	Method and apparatus for reducing rotary stiffness in a support mechanism	355/72
3	Adjustable soft mounts in kinematic lens mounting system	355/53
4	Floor support with passive shear wave cancellation	355/72
5	Stage assembly including a reaction assembly	355/53
6	Stage assembly including a reaction assembly that is connected by actuators	355/72
7	Stage assembly including a damping assembly	355/72
8	REACTION FRAME FOR A WAFER SCANNING STAGE WITH ELECTROMAGNETIC CONNECTIONS TO GROUND	355/72
9	System and method for supporting a device holder with separate components	355/73

	Current XRef	Retrieval Classif
1		355/72
2	310/10; 355/53; 355/76; 378/34	355/53; 355/72
3	359/819	355/53
4	310/10; 355/53; 355/75; 378/34	355/53; 355/72
5	355/72; 355/75	355/53; 355/72
6	310/10; 310/12; 355/52; 355/75	355/72
7	310/10; 310/12; 355/53; 355/75; 355/76; 378/34	355/53; 355/72
8	310/10; 310/12; 318/649; 355/53; 355/76; 378/34	355/53; 355/72
9	310/10; 355/53; 355/72; 355/75; 378/34	355/53; 355/72

	Title	Current R
10	System and method f r h lding a device with minimal deformation	355/73
11	System and method for switching position signals during servo control of a device table	355/72
12	Chamber assembly for an exposure apparatus	355/53
13	Multiple chamber fluid mount	355/53
14	Wafer stage assembly	355/53
15	Support assembly for an exposure apparatus	430/9
16	Wafer stage assembly, servo control system, and method for operating the same	355/72
17	Support assembly for an exposure apparatus	355/72
18	Reticle-focus detector, and charged-particle-beam microlithography apparatus and methods comprising same	250/492.2
19	Stag assembly including a reacti n assembly that is connected by actuat rs	355/53

	Current XRef	Retrieval Classif
10	310/10; 310/12; 355/53; 355/72; 355/75; 355/76; 378/34; 378/35	355/53; 355/72
11	310/10; 310/12; 318/625; 318/632; 355/53; 355/75; 355/76	355/53; 355/72
12	355/30; 356/237.2	355/53
13		355/53
14	428/195.1	355/53
15	355/72	355/72
16	250/492.2; 250/492.22; 355/53; 355/55; 355/67; 355/77; 356/399; 356/400	250/492.2; 250/492.22; 355/53; 355/55; 355/67; 355/72; 355/77; 356/399; 356/400
17	248/638; 355/53	355/53; 355/72
18	250/396R; 250/397; 250/491.1; 250/492.3; 250/494.1	250/492.2
19	355/72; 355/75	355/53; 355/72

	Title	Current R
20	Reticle stage with reaction force cancellation	355/75
21	Stage assembly including a reaction ass mbly	355/53
22	Stage device, control system, and method for stabilizing wafer stage and wafer table	250/492.2
23	Guideless stage	355/72

	Current XRef	Retrieval Classif
20	355/72	355/72
21	355/72; 355/75	355/53; 355/72
22	250/442.11	250/492.2
23	355/53	355/53; 355/72

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2004/02/20 11:39	USPAT;	control near system and wafer near stage and interferometer and circuit	23	15
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	US-PGPUB;	and len near assembly and actuators and 29/\$.ccls.		
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		"5933215"   "6285457"   "2002/0054280").PN.		
2004/02/20 11:19	USPAT	("4952858"   "5661548"   "5739899"   "5789734"   "5917580"   "5917581"	<b>co</b>	9